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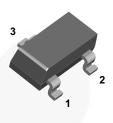
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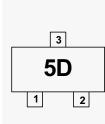


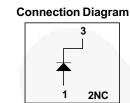
February 2015

MMBD914 Small Signal Diode



SOT-23





Ordering Information

Part Number	Top Mark Package		Packing Method	
MMBD914	5D	SOT-23 3L	Tape and Reel	

Absolute Maximum Ratings(1), (2)

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only. Values are at $T_A = 25^{\circ}\text{C}$ unless otherwise noted.

Symbol	Parameter		Value	Unit
V _{RRM}	Maximum Repetitive Reverse Voltage		100	V
I _{F(AV)}	Average Rectified Forward Current		200	mA
I _{FSM}	Non-Repetitive Peak Forward Surge Current	Pulse Width = 1.0 second	1.0	А
		Pulse Width = 1.0 microsecond	2.0	
T _{STG}	Storage Temperature Range		-55 to +150	°C
TJ	Operating Junction Temperature		150	°C

Notes:

- 1. These ratings are based on a maximum junction temperature of 150° C.
- 2. These are steady-state limits. Fairchild Semiconductor should be consulted on applications involving pulsed or low-duty-cycle operations.

Thermal Characteristics

Values are at $T_A = 25^{\circ}C$ unless otherwise noted.

Symbol	Parameter	Value	Unit
P_{D}	Power Dissipation	350	mW
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	357	°C/W

Electrical Characteristics

Values are at $T_A = 25$ °C unless otherwise noted.

Symbol	Parameter	Conditions	Min.	Max.	Unit
V _R	Breakdown Voltage	I _R = 5.0 μA	75		V
		I _R = 100 μA	100		
V_{F}	Forward Voltage	I _F = 10 mA		1.0	V
I _R	Reverse Current	V _R = 20 V		25	nA
		$V_R = 20 \text{ V}, T_A = 150^{\circ}\text{C}$.	50	μΑ
		V _R = 75 V		5.0	μΑ
C_{T}	Total Capacitance	$V_R = 0$, $f = 1.0 \text{ MHz}$		4.0	pF
t _{rr}	Reverse Recovery Time	$I_F = 10 \text{ mA}, V_R = 6 \text{ V},$ $I_{RR} = 1.0 \text{ mA}, R_L = 100 \Omega$		4.0	ns
V _{FR}	Peak Forward Recovery Voltage	I_F = 50 mA, PEAK SQUARE WAVE PULSE WIDTH = 0.1 μ S 5 kHz - 100 kHz REP RATE		2.5	V

Typical Performance Characteristics

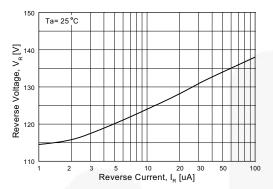


Figure 1. Reverse Voltage vs. Reverse Current BV - 1.0 to 100 μA

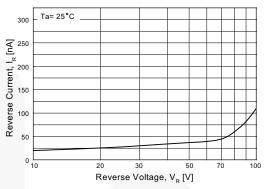


Figure 2. Reverse Current vs. Reverse Voltage I_R - 10 to 100 V

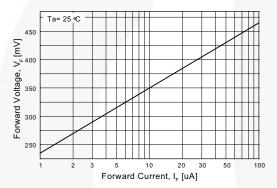


Figure 3. Forward Voltage vs. Forward Current $$V_F$$ - 1.0 to 100 μA

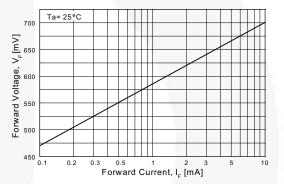


Figure 4. Forward Voltage vs. Forward Current V_F - 0.1 to 10 mA

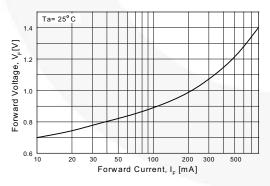


Figure 5. Forward Voltage vs. Forward Current V_F - 10 to 800 mA

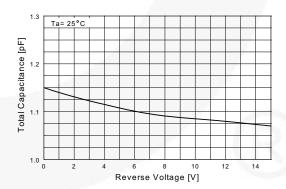


Figure 6. Total Capacitance vs. Reverse Voltage

Typical Performance Characteristics (Continued)

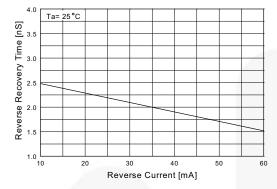


Figure 7. Reverse Recovery Time vs.
Reverse Current

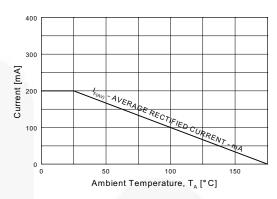


Figure 8. Average Rectified Current($I_{F(AV)}$) vs. Ambient Temperature(T_A)

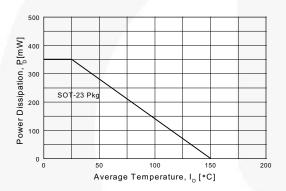


Figure 9. Power Derating Curve

Physical Dimensions

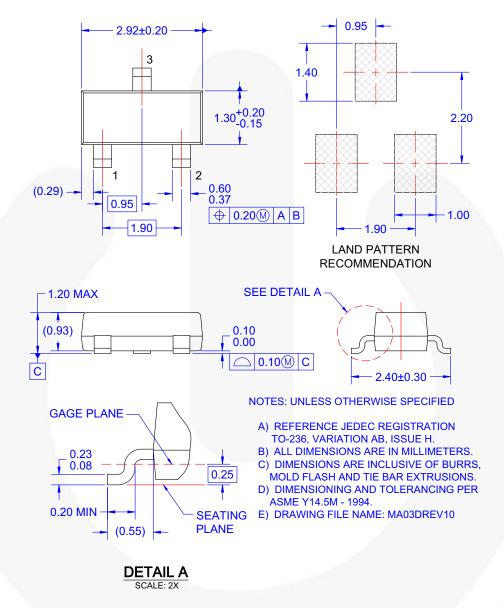


Figure 10. 3-LEAD, SOT23, JEDEC TO-236, LOW PROFILE





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Advance Information	Formative / In Design	Datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
Preliminary	First Production	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.
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